

03500.011946

PATENT APPLICATION

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akira FUNAKOSHI et al.

Application No.: 08/801,464

Filed: February 18, 1997

For: SUBSTRATE CUTTING METHOD AND  
SUBSTRATE CUTTING APPARATUS

Examiner: C. Dexter

Group Art Unit: 3724

November 22, 2002

RECEIVED

NOV 27 2002

TECHNOLOGY CENTER R3700

COMMISSIONER FOR PATENTS  
Washington, D.C. 20231

Sir:

Transmitted herewith is a Supplemental Amendment in the above-identified application.

☒ No additional fee is required.

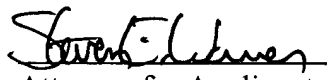
The fee has been calculated as shown below:

CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL CLAIMS	9	MINUS	34	0	x \$ 9 \$18	\$0.00
INDEP. CLAIMS	2	MINUS	6	0	x \$42 \$84	\$0.00
Fee for Multiple Dependent claims \$135°/\$270						
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT---						\$0.00

☐ °Verified Statement claiming small entity status is enclosed, if not filed previously.

- ☐ A check in the amount of \$\_\_\_\_\_ is enclosed including the additional claims fees.
- ☐ Charge \$\_\_\_\_ to Deposit Account No. 06-1205. A duplicate of this sheet is enclosed.
- ☒ Any prior general authorization to charge an issue fee under 37 C.F.R. § 1.18 to Deposit Account No. 06-1205 is hereby revoked. The Commissioner is hereby authorized to charge any additional fees under 37 C.F.R. §§ 1.16 and 1.17 which may be required during the entire pendency of this application, or to credit any overpayment, to Deposit Account No. 06-1205. A duplicate of this paper is enclosed.
- ☐ A check in the amount of \$\_\_\_\_\_ to cover the Extension fee for response within \_\_\_\_\_ additional months is enclosed.
- ☐ A check in the amount of \$\_\_\_\_\_ to cover the Information Disclosure Statement fee is enclosed.
- ☒ Applicants' undersigned attorney may be reached in our Washington, D.C. office by telephone at (202) 530-1010. All correspondence should continue to be directed to our address given below.

Respectfully submitted,

  
Attorney for Applicants  
Steven E. Warner  
Registration No. 33,326

FITZPATRICK, CELLA, HARPER & SCINTO  
30 Rockefeller Plaza  
New York, New York 10112-3801  
Facsimile: (212) 218-2200

SEW/eab



03500.011946

*291 H 12/13/02*  
PATENT APPLICATION  
*Hart*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
: Examiner: C. Dexter  
Akira FUNAKOSHI et al. )  
: Group Art Unit: 3724  
Application No.: 08/801,464 )  
:   
Filed: February 18, 1997 )  
:   
For: SUBSTRATE CUTTING METHOD AND ) November 22, 2002  
SUBSTRATE CUTTING APPARATUS :  
:

The Commissioner for Patents  
Washington, D.C. 20231

**RECEIVED**  
NOV 27 2002  
TECHNOLOGY CENTER H3700

SUPPLEMENTAL AMENDMENT

Sir:

In response to the Official Action dated October 22, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please AMEND claim 35, as follows. A marked-up copy of the amended claim, showing the changes made thereto, is attached in Appendix A. For the Examiner's convenience, all claims currently pending in this application have been reproduced below: